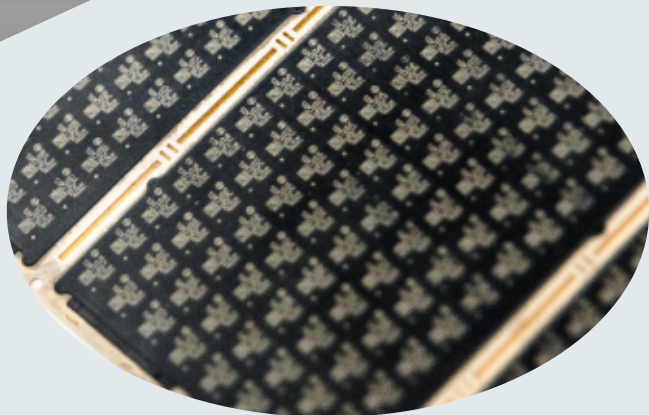
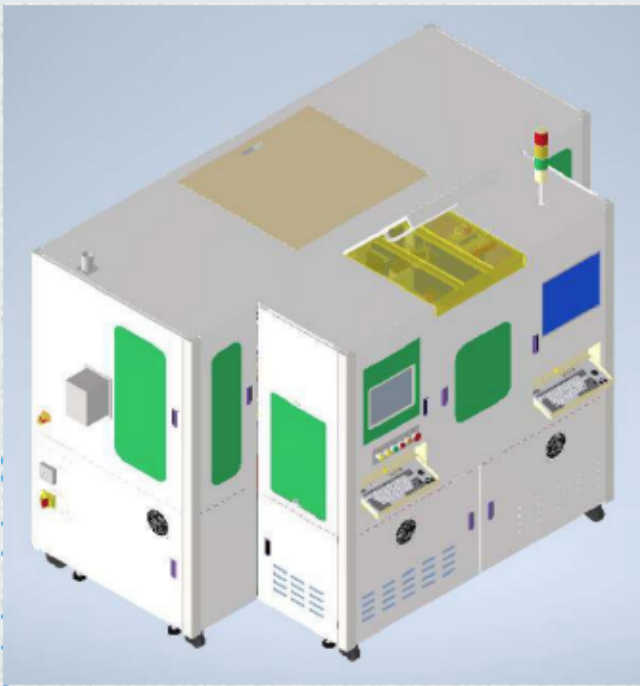


DUAL HEAD MARKING.



SEMICONDUCTOR INDUSTRY & PACKAGING SOLUTION:

IDI Laser Services' latest offering is a dual head substrate laser marking system designed to mark Strip Lead frames. Featuring fully automatic loading and unloading from either Slot Magazine Loader or Stacking tray, and integrated with a built in CO-Axis VISION and high-speed transfer system, this handler is packed with features to ensure laser marking is done precisely with traceable mark for lead frames of different package types, such as QFN, LGA, TLA, BGA and SMD. Employing state-of-the-art technology and highly customisable to your needs, our dual-head marking solution is sure to fit any semiconductor manufacturing requirements.



- **UNIQUE FEATURES:**

Pre-mark clamping- reduces warpage with a mechanical jig and vacuum suction

- **VARIOUS CHOICES FOR LASER**

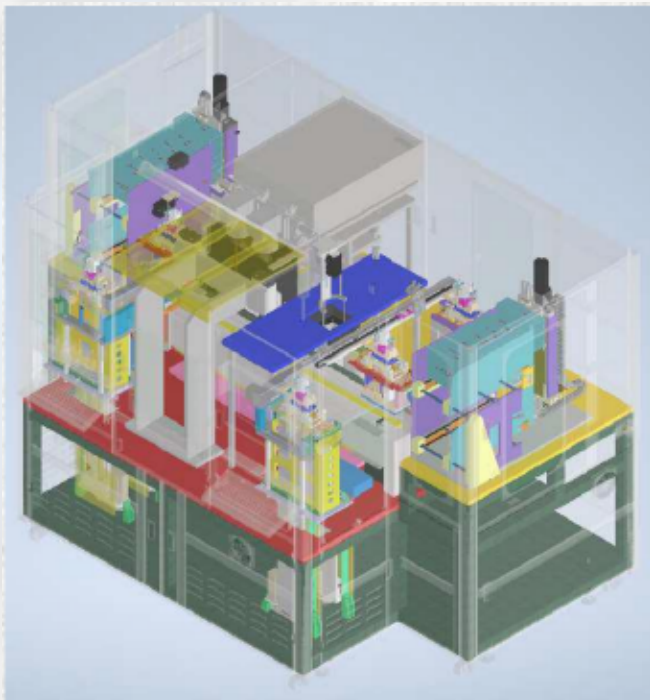
IDI Laser Services is able to customise your machine with UV, Green, and Fiber laser heads for your machine.

- **SMALL INDUSTRIAL FOOTPRINT**

Our customised build can be as small as 1650mm (H) by 2400mm (W) by 1600mm (L).

- **CUSTOM SOFTWARE SUITE**

Various customisable parameters, easy to pick up and use, fully configurable based on operations.



MACHINE SPECIFICATIONS:

Please Contact us for the Full Brochure!

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